

AP7354

150mA ULTRA-LOW QUIESCENT CURRENT LDO WITH ENABLE

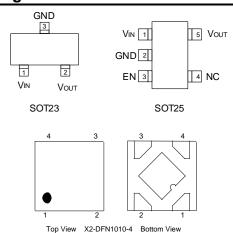
Description

The AP7354 is a low dropout regulator with high output voltage accuracy. The AP7354 includes a voltage reference, error amplifier, current limit circuit, and an enable input to turn it on/off. With the integrated resistor network, fixed output voltage versions can be delivered.

With its ultra-low quiescent current, the AP7354 is well-suited for low-power handheld, wearable devices, and other battery-operated devices requiring an extended time period until new battery replacement.

The AP7354 is available in SOT23, SOT25, and X2-DFN1010-4 packages.

Pad Assignments



Pin 1 – V_{OUT} , Pin 2 – GND, Pin 3 – EN, Pin 4 – V_{IN}

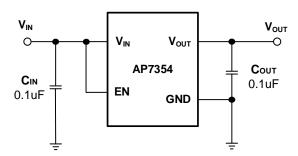
Features

- Wide V_{IN} Range: 2.0V to 5.5V
- Guarantee Output Current: 150mA
- Output Voltage Range: 1.2V to 4.5V
- V_{OUT} Accuracy: ±1%
- Quiescent Current as Low as 0.25µA
- Output Discharge Available for Devices in SOT25 or DFN1010
- Typical Standby Current: 0.02µA
- ESD Protection Exceeds JESD 22
 - Exceeds 4000V Human Body Model (A114)
 - Exceeds 400V Machine Model (A115)
- Latch-Up Exceeds 400mA per JESD 78, Class I
- Totally Lead-Free & and Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Applications

- Wearable Electronics
- Sensor Module for Internet-of-Things (IoT)
- Wireless Communication Module
- Battery-Operated Device
- Camera
- Image Sensor

Typical Applications Circuit (Note 4)

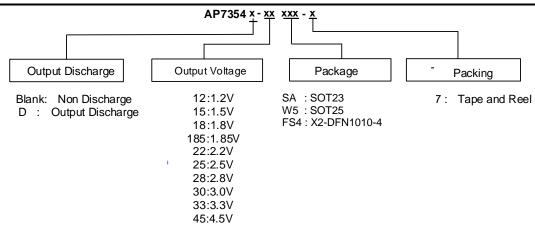


Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. X5R- and X7R-type capacitors are suggested due to their minimal variation in value and ESR over temperature.



Ordering Information



	SOT23	SOT25	SOT25	7" Tape	and Reel
Output Voltage		Without Discharge	With Discharge	Quantity	Part Number Suffix
1.2	AP7354-12SA-7	AP7354-12W5-7	AP7354D-12W5-7	3000/Tape & Reel	-7
1.5	AP7354-15SA-7	AP7354-15W5-7	AP7354D-15W5-7	3000/Tape & Reel	-7
1.8	AP7354-18SA-7	AP7354-18W5-7	AP7354D-18W5-7	3000/Tape & Reel	-7
1.85	AP7354-185SA-7	AP7354-185W5-7	AP7354D-185W5-7	3000/Tape & Reel	-7
2.2	AP7354-22SA-7		_	3000/Tape & Reel	-7
2.5	AP7354-25SA-7	AP7354-25W5-7	AP7354D-25W5-7	3000/Tape & Reel	-7
2.8	AP7354-28SA-7	AP7354-28W5-7	AP7354D-28W5-7	3000/Tape & Reel	-7
3.0	AP7354-30SA-7	AP7354-30W5-7	AP7354D-30W5-7	3000/Tape & Reel	-7
3.3	AP7354-33SA-7	AP7354-33W5-7	AP7354D-33W5-7	3000/Tape & Reel	-7
4.5	AP7354-45SA-7	AP7354-45W5-7	AP7354D-45W5-7	3000/Tape & Reel	-7

Output	X2-DFN1010-4	X2-DFN1010-4	7" Tape	7" Tape and Reel		
Voltage	Without Discharge	With Discharge	Quantity	Part Number Suffix		
1.2	AP7354-12FS4-7	AP7354D-12FS4-7	5000/Tape & Reel	-7		
1.5	AP7354-15FS4-7	AP7354D-15FS4-7	5000/Tape & Reel	-7		
1.8	AP7354-18FS4-7	AP7354D-18FS4-7	5000/Tape & Reel	-7		
1.85	AP7354-185FS4-7	AP7354D-185FS4-7	5000/Tape & Reel	-7		
2.5	AP7354-25FS4-7	AP7354D-25FS4-7	5000/Tape & Reel	-7		
2.8	AP7354-28FS4-7	AP7354D-28FS4-7	5000/Tape & Reel	-7		
3.0	AP7354-30FS4-7	AP7354D-30FS4-7	5000/Tape & Reel	-7		
3.3	AP7354-33FS4-7	AP7354D-33FS4-7	5000/Tape & Reel	-7		
4.5	AP7354-45FS4-7	AP7354D-45FS4-7	5000/Tape & Reel	-7		

 V_{OUT}

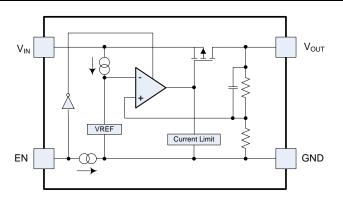
GND



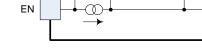
Pad Description

Pin Number SOT25	Pin Number SOT23	Pad Number X2-DFN1010-4	_	Function
3	Not Available	3	EN	Chip Enable—This should be driven either high or low and must not be floating. Driving EN high enables regulator output, while pulling it low places regulator into shutdown mode.
2	3	2	GND	Ground
5	2	1	V _{out}	Output Voltage
1	1	4	V _{IN}	Power Input
_	_	Center Pad	_	No connect or ground. Note: Chip Ground must be through GND pin.

Functional Block Diagram



AP7354 (Without Discharge)



VREF

Current Limit

AP7354D (With Discharge)



Absolute Maximum Ratings (Note 5)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	4	kV
ESD MM	Machine Model ESD Protection	400	V
V _{IN}	Input Voltage	6.0	V
V _{EN}	Input Voltage at EN pad	6.0	V
V _{OUT}	Output Voltage to GND	-0.3 to V _{IN} +0.3	V
T _A	Operating Ambient Temperature	-40 to +85	°C
TJ	Maximum Junction Temperature	+125	°C
T _{STG}	Storage Temperature	-55 to +125	°C
P _D	Power Dissipation (Note 6)	315	mW

Notes:

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V _{IN}	Input Voltage	2.0	5.5	V
I _{OUT}	Output Current	0	150	mA
T _A	Operating Ambient Temperature	-40	+85	°C

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability
 This is based on an application temperature of 40°C. Derate 3.75 mW per °C for each degree above 40°C.



 $\textbf{Electrical Characteristics} \ (@T_{A} = +25 ^{\circ}\text{C}) \ V_{EN} = V_{IN} = V_{OUT} + 1 \text{V} \ (1.5 \text{V} < V_{OUT} \leq 4.5 \text{V} \), \ V_{EN} = V_{IN} = 2.5 \text{V} \ (V_{OUT} \leq 1.5 \text{V}), \ I_{OUT} = 1 \text{mA}, \ I_{OUT} =$ C_{IN} = C_{OUT} = $0.1 \mu F$, unless otherwise specified.)

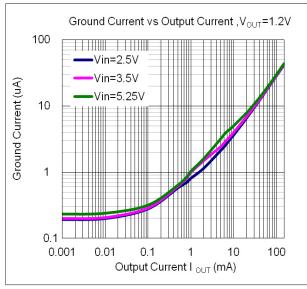
Parameter	Conditions		Min	Тур	Max	Unit
Input Voltage	T _A = -40°C to +85°C		2.0	_	5.5	V
	V _{OUT} > 2.0V	T _A = +25°C	-1	_	+1	- %
	I _{OUT} = 1mA	T _A = -40°C to +85°C	-2	_	+2	
Output Voltage Accuracy	V _{OUT} ≤ 2.0V	T _A = +25°C	-40	_	40	
	I _{OUT} = 1mA	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	-80	_	80	mV
Line Regulation (ΔV _{OUT} /ΔV _{IN} /V _{OUT})	MAX (V _{OUT} + 1.0V, (All Versions Excep		_	0.02	0.1	%/V
Lond Dowleties (A)/	1mA ≤ I _{OUT} ≤ 150m	A (All Versions Except 4.5V)	-40	_	40	mV
Load Regulation (∆V _{OUT)}	1mA ≤ I _{OUT} ≤ 150m	A (Applicable to 4.5V Version)	-55	_	55	mV
Short Circuit Current Limit (Note 7)	V _{OUT} = 0V		_	60	_	mA
Quiescent Current (Note 8)	I _{OUT} = 0 mA		_	0.25	0.6	μA
I _{STANDBY}	Set EN Low, No Lo	ad	_	0.02	0.2	μA
Output Current	_		150	_	_	mA
		V _{OUT} = 1.2V	_	0.60	0.90	V
		V _{OUT} = 1.5V	_	0.43	0.75	
		V _{OUT} = 1.8V	_	0.33	0.60	
	I _{OUT} = 150mA	V _{OUT} =1.85V	_	0.32	0.58	
		V _{OUT} = 2.2V	_	0.27	0.52	
Dropout Voltage (Note 9)		V _{OUT} = 2.5V	_	0.22	0.48	
		V _{OUT} = 2.8V	_	0.19	0.40	
		V _{OUT} = 3.0V	_	0.18	0.35	
		V _{OUT} = 3.3V	_	0.16	0.35	
		V _{OUT} = 4.5V	_	0.14	0.35	
EN Input Low Voltage	_		_	_	0.4	V
EN Input High Voltage	_		1.0	_	5.5	V
Active Output Discharge Resistance (Note 10)	V _{IN} = 4.0V, V _{EN} = 0	V	_	35	_	Ω
		SOT23 Package	_	170	_	°C/W
Θ _{JA} Thermal Resistance Junction-to-Ambient	Note 11	SOT25 Package	_	162	_	
		X2-DFN1010-4	_	295	_	
		SOT23 Package	_	43	_	
θ _{JC} Thermal Resistance Junction-to-Case	Note 11	SOT25 Package	_	38	_	°C/W
	X2-DFN1010-4		_	120	_	

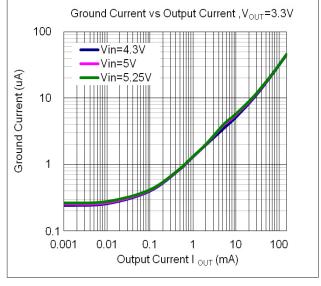
Notes:

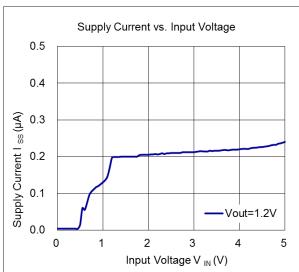
- 7. Short-circuit current is measured with V_{OUT} pulled to GND.
- 8. Quiescent current defined as the difference in current between the input and the output.
- 9. Dropout voltage is the voltage difference between the input and the output at which the output voltage drops 2% below its nominal value.
- 10. AP7354 is available with two options: built-in discharge (AP7354D) and non-discharge (AP7354).

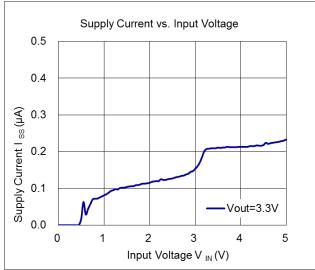
 11. Test condition: Device mounted on 1" x 1" FR-4 MRP substrate PCB, 2oz copper, with minimum recommended pad layout..

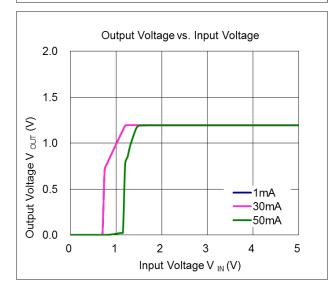


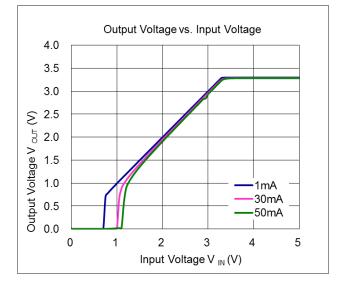




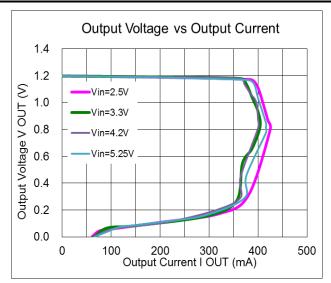


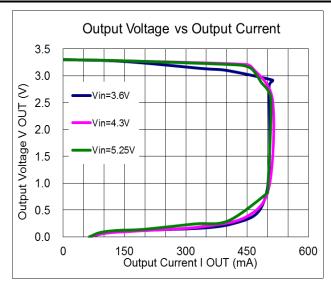


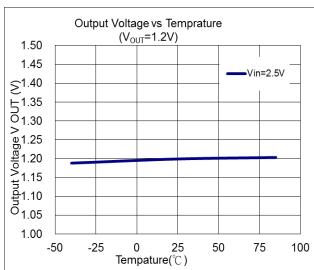


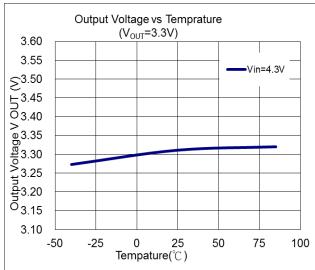


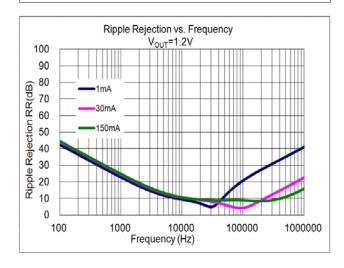


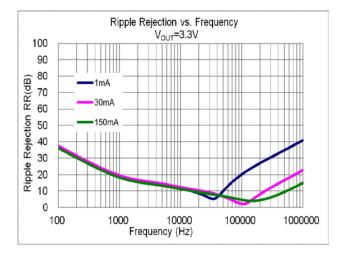






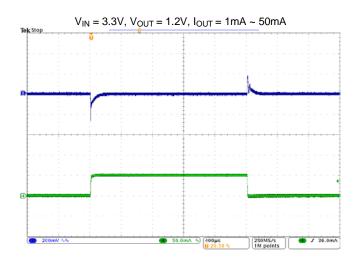


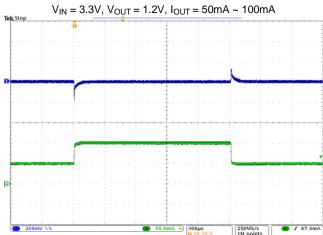


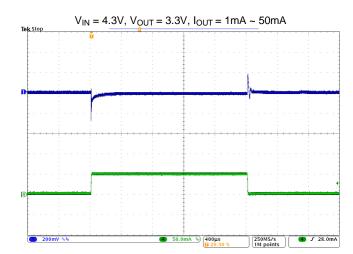


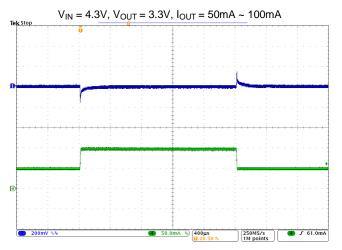


Load Transient Response ($C_{IN} = C_{OUT} = 0.1 \mu F$, $Tr = Tf = 5.0 \mu s$, unless otherwise specified)







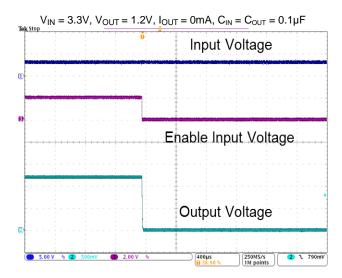


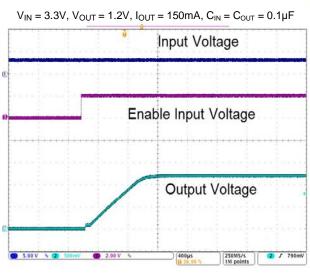


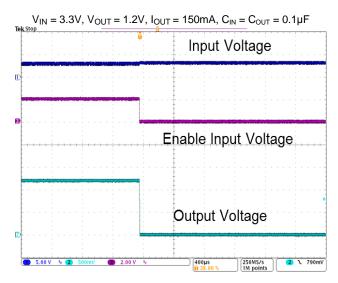
TURN ON

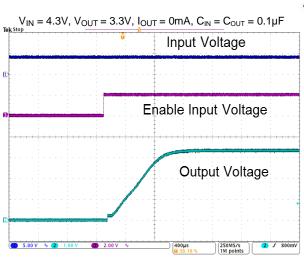
V_{IN} = 3.3V, V_{OUT} = 1.2V, I_{OUT} = 0mA, C_{IN} = C_{OUT} = 0.1μF Input Voltage Enable Input Voltage Output Voltage

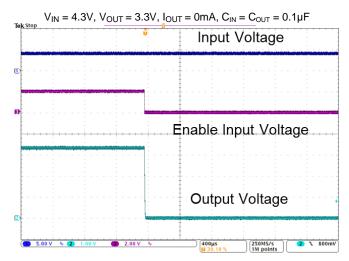
TURN OFF









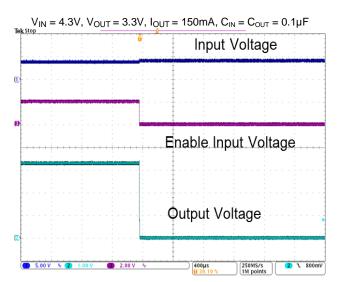




TURN ON

V_{IN} = 4.3V, V_{OUT} = 3.3V, I_{OUT} = 150mA, C_{IN} = C_{OUT} = 0.1μF Input Voltage Enable Input Voltage Output Voltage

TURN OFF





Application Information

Output Capacitor

An output capacitor (C_{OUT}) is required to improve transient response and maintain stability. The AP7354 is stable with very small ceramic output capacitors. The equivalent series resistance (ESR) and capacitance drive the selection. If the application has large load variations, it is recommended to utilize low-ESR bulk capacitors. It is recommended to place ceramic capacitors as close as possible to the load and the GND pad. Care must be taken to reduce the impedance in the layout.

Input Capacitor

To prevent the input voltage from dropping during load steps, it is recommended to utilize an input capacitor (C_{IN}). A minimum $0.1\mu F$ ceramic capacitor is recommended between V_{IN} and GND pad to decouple input power supply glitch. This input capacitor must be located as close as possible to the device to assure input stability and reduce noise. For PCB layout, a wide copper trace is required for both V_{IN} and GND pad.

Enable Control

The AP7354 is turned on by setting the EN pad high, and is turned off by pulling them low. If this feature is not used, the EN pad should be tied to V_{IN} pad to keep the regulator output on at all time. To ensure proper operation, the signal source used to drive the EN pad must be able to swing above and below the specified turn-on/off voltage thresholds listed in the Electrical Characteristics section.

Layout Considerations

For good ground loop and stability, the input and output capacitors must be located close to the input, output, and GND pad of the device. The regulator GND pad must be connected to the external circuit ground to reduce voltage drop caused by trace impedance. Ground plane is generally used to reduce trace impedance. Wide trace must be used for large current paths from V_{IN} to V_{OUT} and load circuit.

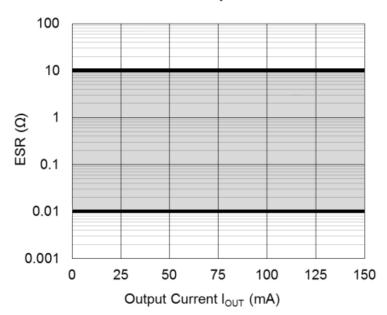
ESR vs. Output Current

A ceramic type output capacitor is recommended for this series; however, the other output capacitors with low ESR also can be used. The relations between I_{OUT} (output current) and ESR of an output capacitor are shown below. The stable region is marked as the hatched area in the graph.

Measurement Conditions:

Frequency Band: 10Hz to 2MHz
 Temperature: -40°C to +85°C

ESR vs. Output Current





Marking Information

(1) SOT23

(Top View)

3

 $\underline{\mathsf{XXX}}$ $\underline{Y} \underline{W} \underline{X}$ 2

XXX: Identification Code

Y : Year 0 to 9

 \underline{W} : Week: A to Z: 1 to 26 week;

a to z: 27 to 52 week; z represents

52 and 53 week X: Internal Code

Part Number	Package	Identification Code
AP7354-12SA-7	SOT23	A8A
AP7354-15SA-7	SOT23	A8B
AP7354-18SA-7	SOT23	A8C
AP7354-185SA-7	SOT23	A8D
AP7354-22SA-7	SOT23	A8K
AP7354-25SA-7	SOT23	A8E
AP7354-28SA-7	SOT23	A8F
AP7354-30SA-7	SOT23	A8G
AP7354-33SA-7	SOT23	A8H
AP7354-45SA-7	SOT23	A8J



Marking Information

(2) SOT25

(Top View)

5 4 <u>XXX</u> <u>Y W X</u>

XXX: Identification Code

Y: Year 0 to 9

 \underline{W} : Week: A to Z: 1 to 26 week;

a to z : 27 to 52 week; z represents 52 and 53 week

X : Internal Code

Part Number	Package	Identification Code
AP7354-12W5-7	SOT25	A8A
AP7354-15W5-7	SOT25	A8B
AP7354-18W5-7	SOT25	A8C
AP7354-185W5-7	SOT25	A8D
AP7354-25W5-7	SOT25	A8E
AP7354-28W5-7	SOT25	A8F
AP7354-30W5-7	SOT25	A8G
AP7354-33W5-7	SOT25	A8H
AP7354-45W5-7	SOT25	A8J
AP7354D-12W5-7	SOT25	A9A
AP7354D-15W5-7	SOT25	A9B
AP7354D-18W5-7	SOT25	A9C
AP7354D-185W5-7	SOT25	A9D
AP7354D-25W5-7	SOT25	A9E
AP7354D-28W5-7	SOT25	A9F
AP7354D-30W5-7	SOT25	A9G
AP7354D-33W5-7	SOT25	А9Н
AP7354D-45W5-7	SOT25	A9J



Marking Information

(3) X2-DFN1010-4

(Top View)

<u>XXX</u> <u>Y W X</u> XXX: Identification Code

Y: Year: 0~9

W: Week: A~Z: 1~26 week;

a~z: 27~52 week; z represents

52 and 53 week X: Internal Code

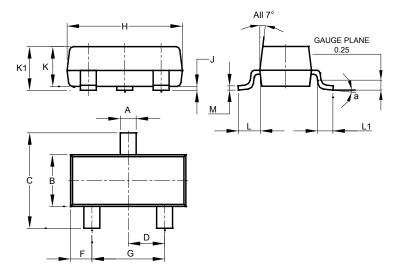
Part Number	\mathbf{V}_{OUT}	Package	Identification Code
AP7354-12FS4-7	1.2V	X2-DFN1010-4	A8A
AP7354-15FS4-7	1.5V	X2-DFN1010-4	A8B
AP7354-18FS4-7	1.8V	X2-DFN1010-4	A8C
AP7354-185FS4-7	1.85V	X2-DFN1010-4	A8D
AP7354-25FS4-7	2.5V	X2-DFN1010-4	A8E
AP7354-28FS4-7	2.8V	X2-DFN1010-4	A8F
AP7354-30FS4-7	3.0V	X2-DFN1010-4	A8G
AP7354-33FS4-7	3.3V	X2-DFN1010-4	A8H
AP7354-45FS4-7	4.5V	X2-DFN1010-4	A8J
AP7354D-12FS4-7	1.2V	X2-DFN1010-4	A9A
AP7354D-15FS4-7	1.5V	X2-DFN1010-4	A9B
AP7354D-18FS4-7	1.8V	X2-DFN1010-4	A9C
AP7354D-185FS4-7	1.85V	X2-DFN1010-4	A9D
AP7354D-25FS4-7	2.5V	X2-DFN1010-4	A9E
AP7354D-28FS4-7	2.8V	X2-DFN1010-4	A9F
AP7354D-30FS4-7	3.0V	X2-DFN1010-4	A9G
AP7354D-33FS4-7	3.3V	X2-DFN1010-4	А9Н
AP7354D-45FS4-7	4.5V	X2-DFN1010-4	A9J



Package Outline Dimensions

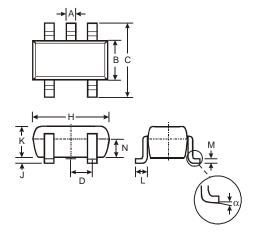
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) SOT23



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
M	0.085	0.150	0.110		
а	0°	8°	_		
All	Dimens	ions in	mm		

(2) SOT25



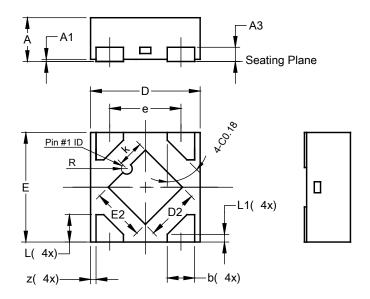
SOT25					
Dim	Min	Max	Тур		
Α	0.35	0.50	0.38		
В	1.50	1.70	1.60		
C	2.70	3.00	2.80		
D	_	_	0.95		
Η	2.90	3.10	3.00		
7	0.013	0.10	0.05		
K	1.00	1.30	1.10		
L	0.35	0.55	0.40		
M	0.10	0.20	0.15		
N	0.70	0.80	0.75		
α	0°	8°			
All D	imensi	ons in	mm		



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

(3) X2-DFN1010-4 (Type B)

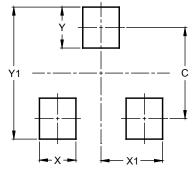


X2-	X2-DFN1010-4 (Type B)					
Dim	Min	Max	Тур			
Α	-	0.40	0.39			
A1	0.00	0.05	0.02			
A3	-	-	0.13			
b	0.20	0.30	0.25			
D	0.95	1.05	1.00			
D2	0.43	0.53	0.48			
Е	0.95	1.05	1.00			
E2	0.43	0.53	0.48			
е	-	-	0.65			
k	0.19	0.29	0.24			
L	0.20	0.30	0.25			
L1	0.02	0.12	0.07			
R	0.02	0.08	0.05			
Z	-	-	0.050			
All	Dimens	ions in	mm			

Suggested Pad Layout

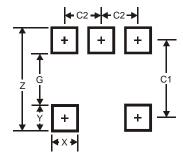
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Υ	0.9
Y1	2.9

(2) SOT25



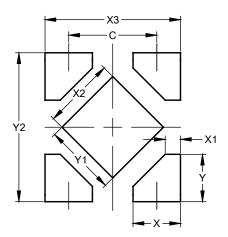
Dimensions	Value
Z	3.20
G	1.60
Х	0.55
Υ	0.80
C1	2.40
C2	0.95



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

(3) X2-DFN1010-4 (Type B)



Dimensions	Value (in mm)	
С	0.650	
Х	0.350	
X1	0.112	
X2	0.530	
Х3	1.00	
Y	0.350	
Y1	0.530	
Y2	1.100	



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